



# PBSS4520X-Q

20 V, 5 A NPN low VCEsat transistor

19 January 2024

Product data sheet

## 1. General description

NPN low VCEsat transistor in a SOT89 (SC-62/TO-243) small and flat lead Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS5520X-Q

## 2. Features and benefits

- High  $h_{FE}$  and low  $V_{CEsat}$  at high current operation
- High collector current capability:  $I_C$  maximum 5 A
- Higher efficiency leading to less heat generation
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Medium power peripheral drivers, e.g. fans and motors
- Strobe flash units for DSC and mobile phones
- Inverter applications, e.g. TFT displays
- Power switch for LAN and ADSL systems
- Medium power DC-to-DC conversion
- Battery chargers

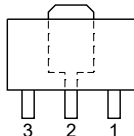
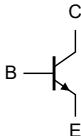
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	20	V
$I_C$	collector current		-	-	5	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1$ ms	-	-	10	A
$R_{CEsat}$	collector-emitter saturation resistance	$I_C = 5$ A; $I_B = 500$ mA; pulsed; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C	-	32	44	m $\Omega$

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	 SOT89	 sym123
2	C	collector		
3	B	base		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS4520X-Q	SOT89	plastic, surface-mounted package; 3 leads; 1.5 mm pitch; 4.5 mm x 2.5 mm x 1.5 mm body	SOT89

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PBSS4520X-Q	%1F

[1] % = placeholder for manufacturing site code

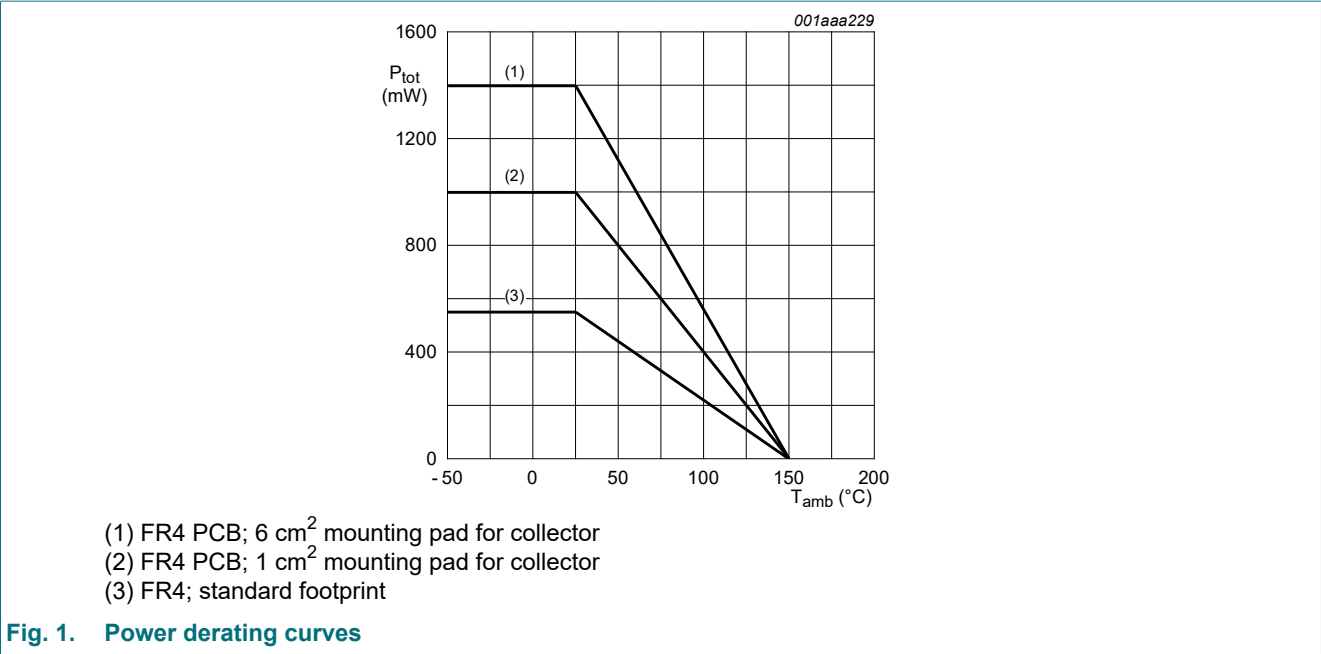
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter		-	20	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	20	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	5	V
I <sub>C</sub>	collector current			-	5	A
I <sub>CRM</sub>	repetitive peak collector current		[1] [2]	-	7	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	10	A
I <sub>B</sub>	base current			-	1	A
I <sub>BM</sub>	peak base current	single pulse; t <sub>p</sub> ≤ 1 ms		-	2	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2] [3]	-	2.5	W
			[2]	-	0.55	W
			[4]	-	1	W
			[5]	-	1.4	W
			[6]	-	1.6	W
T <sub>j</sub>	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-65	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Operated under pulsed conditions: pulse width t<sub>p</sub> ≤ 10 ms; duty cycle δ ≤ 0.2.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[3] Operated under pulsed conditions: t<sub>p</sub> ≤ 10 ms; δ ≤ 0.2.  
[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.  
[5] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.  
[6] Device mounted on a 7 cm<sup>2</sup> ceramic PCB, 1 cm<sup>2</sup> single-sided copper and tin-plated.

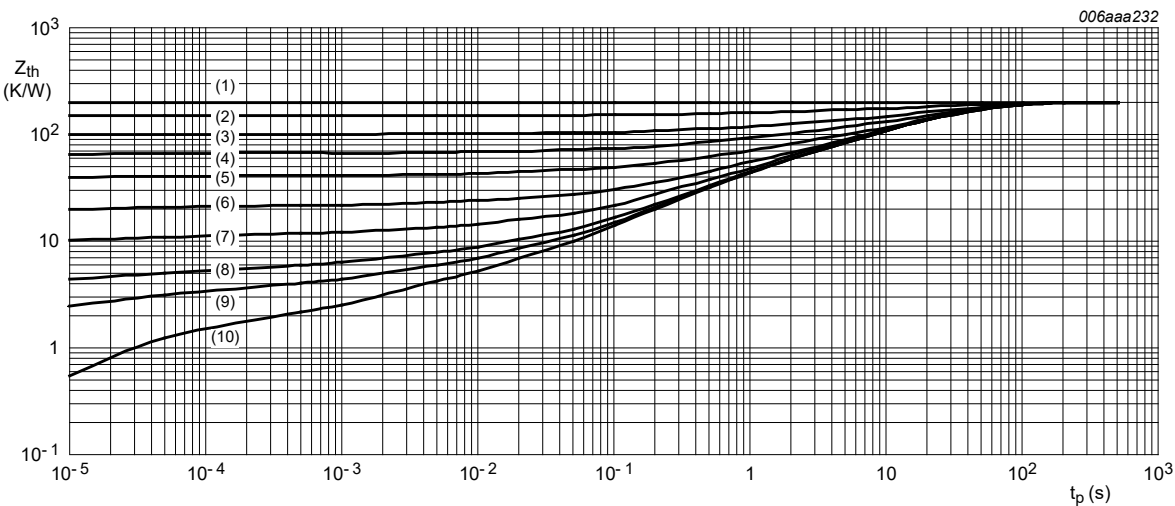


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	50	K/W
			[1]	-	-	225	K/W
			[3]	-	-	125	K/W
			[4]	-	-	90	K/W
			[5]	-	-	80	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	16	K/W

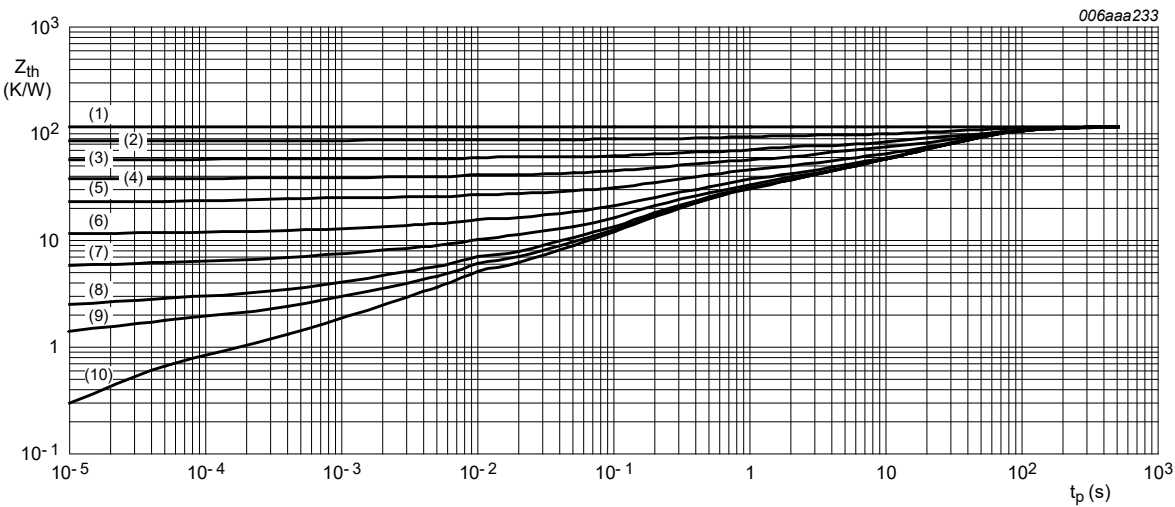
- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Operated under pulsed conditions:  $t_p \leq 10\text{ ms}$ ;  $\delta \leq 0.2$ .  
[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.  
[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.  
[5] Device mounted on a 7 cm<sup>2</sup> ceramic PCB, 1 cm<sup>2</sup> single-sided copper and tin-plated.



Mounted on FR4 PCB; standard footprint

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

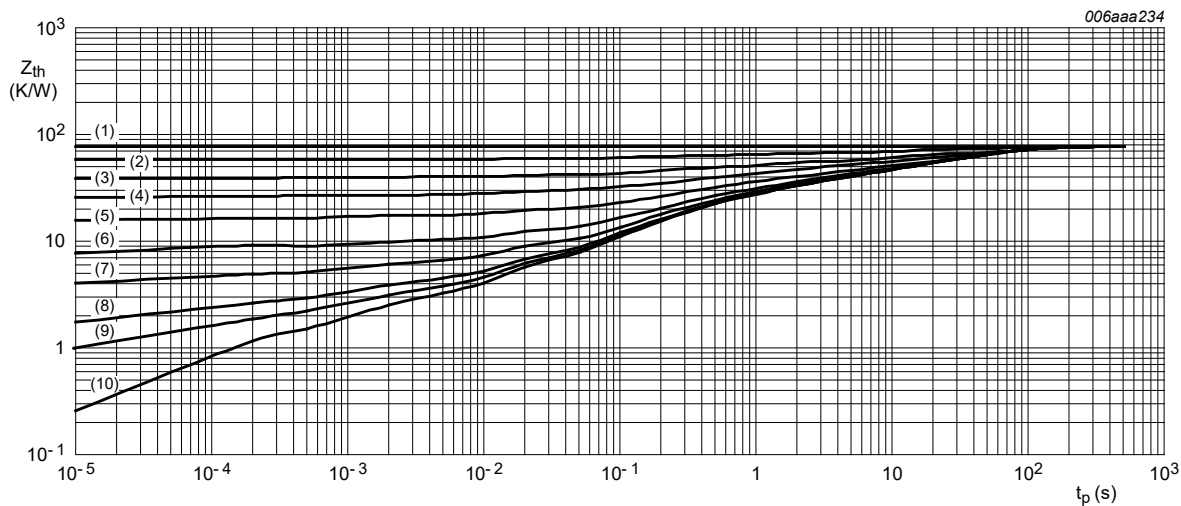
Fig. 2. Transient thermal impedance as a function of pulse duration; typical values



Mounted on FR4 PCB; mounting pad for collector 1 cm<sup>2</sup>

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

Fig. 3. Transient thermal impedance as a function of pulse duration; typical values



Mounted on FR4 printed-circuit board; mounting pad for collector 6 cm<sup>2</sup>

- (1)  $\delta = 1$
- (2)  $\delta = 0.75$
- (3)  $\delta = 0.5$
- (4)  $\delta = 0.33$
- (5)  $\delta = 0.2$
- (6)  $\delta = 0.1$
- (7)  $\delta = 0.05$
- (8)  $\delta = 0.02$
- (9)  $\delta = 0.01$
- (10)  $\delta = 0$

Fig. 4. Transient thermal impedance as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	100	nA
		V <sub>CB</sub> = 20 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	50	µA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C		-	-	100	nA
I <sub>CES</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 20 V; V <sub>BE</sub> = 0 V; T <sub>amb</sub> = 25 °C		-	-	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 0.5 A; T <sub>amb</sub> = 25 °C		300	450	-	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		300	440	-	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 2 A; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		250	420	-	
		V <sub>CE</sub> = 2 V; I <sub>C</sub> = 5 A; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		200	380	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 0.5 A; I <sub>B</sub> = 5 mA; T <sub>amb</sub> = 25 °C		-	35	50	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 10 mA; T <sub>amb</sub> = 25 °C		-	50	70	mV
		I <sub>C</sub> = 2.5 A; I <sub>B</sub> = 125 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	85	120	mV
		I <sub>C</sub> = 4 A; I <sub>B</sub> = 200 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	130	180	mV
		I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	160	220	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance			-	32	44	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 4 A; I <sub>B</sub> = 200 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	0.9	1.05	V
		I <sub>C</sub> = 5 A; I <sub>B</sub> = 500 mA; pulsed; t <sub>p</sub> ≤ 300 µs; δ ≤ 0.02; T <sub>amb</sub> = 25 °C		-	0.96	1.1	V
V <sub>BEon</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = 2 V; I <sub>C</sub> = 2 A; T <sub>amb</sub> = 25 °C		-	0.74	0.85	V
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 100 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C		100	125	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C		-	90	110	pF

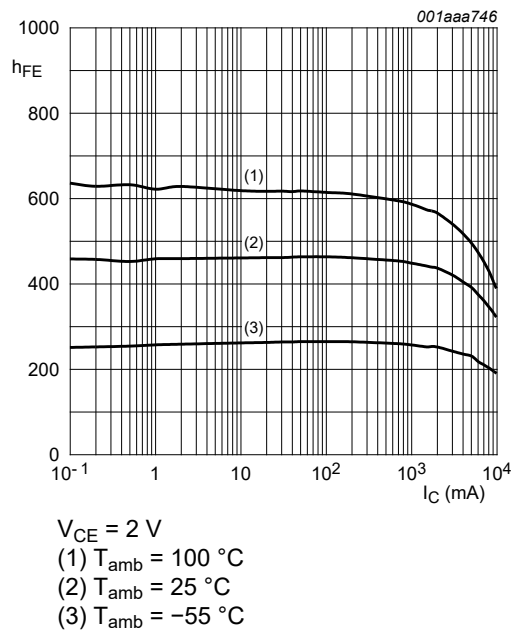


Fig. 5. DC current gain as a function of collector current; typical values

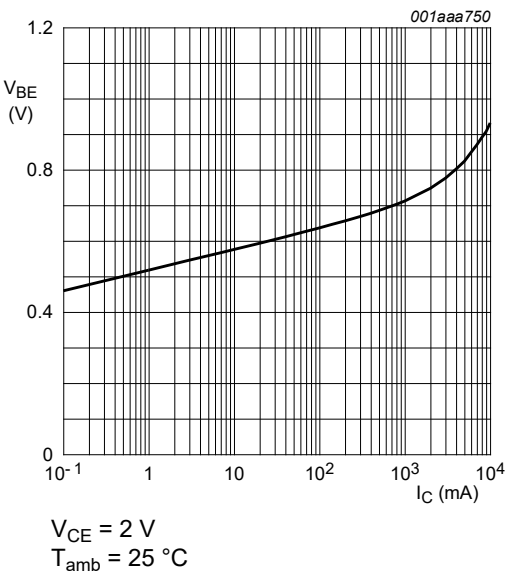


Fig. 6. Base-emitter voltage as a function of collector current; typical values

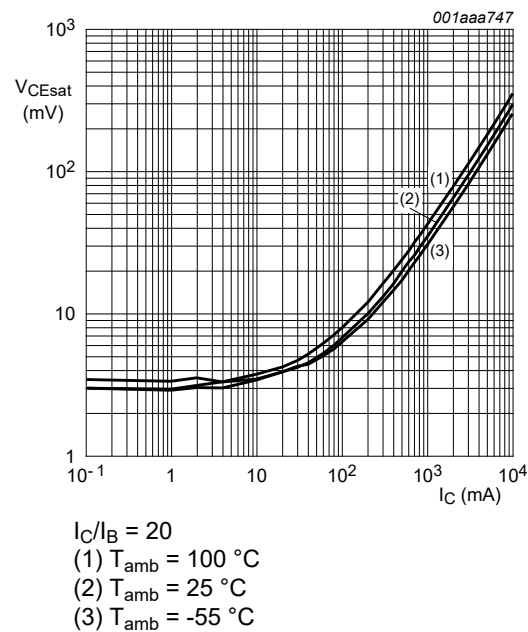


Fig. 7. Collector-emitter saturation voltage as a function of collector current; typical values

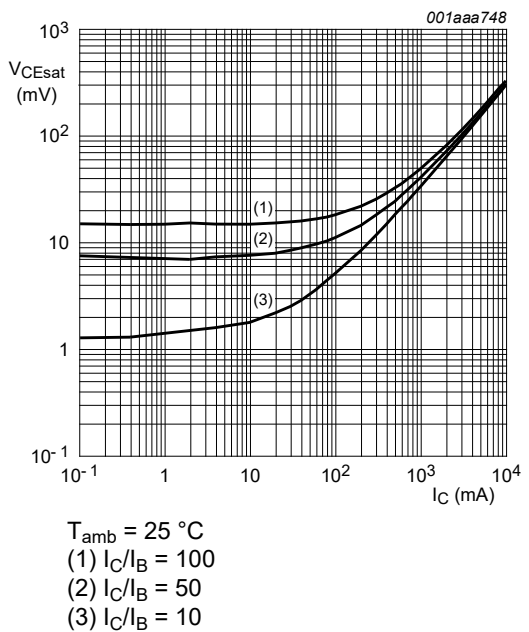
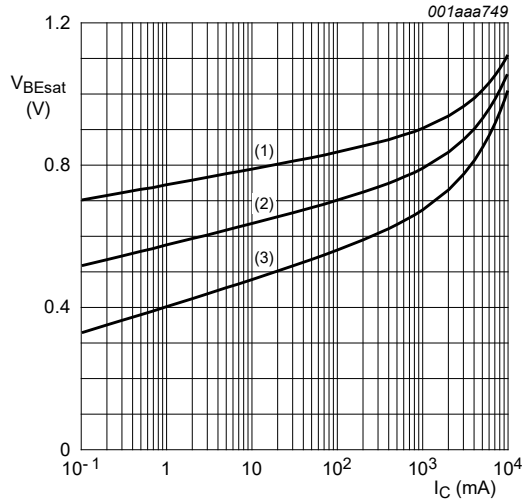
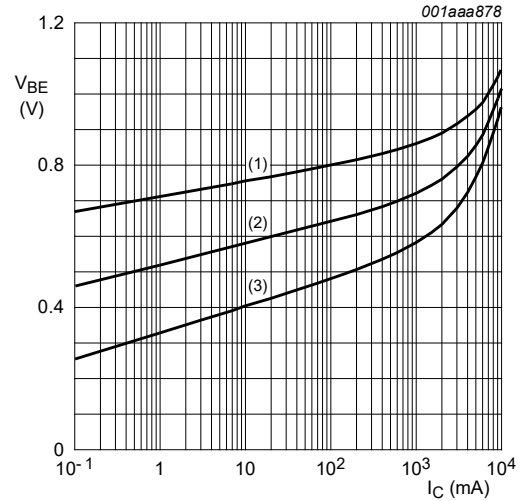


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values



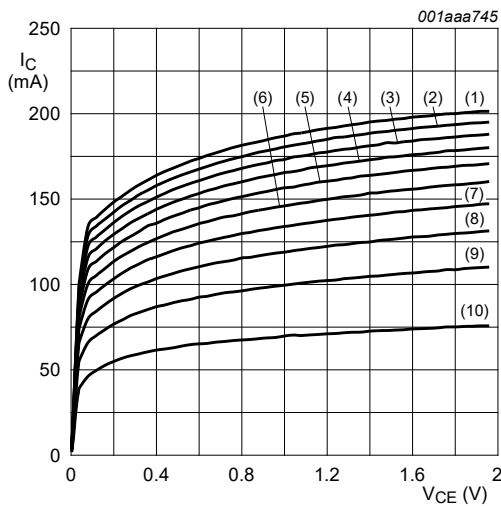
$I_C/I_B = 20$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 9. Base-emitter saturation voltage as a function of collector current; typical values**



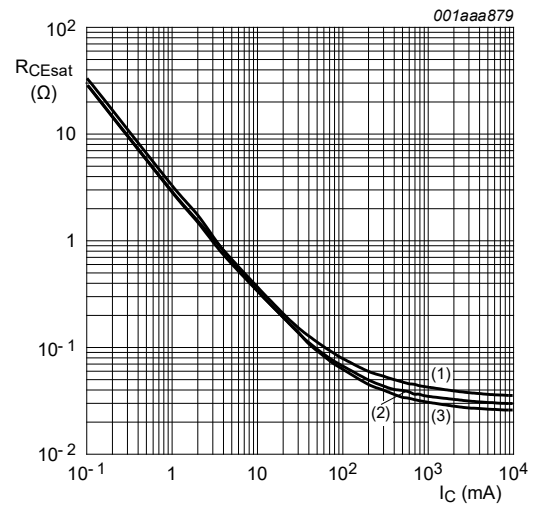
$V_{CE} = 2\text{ V}$   
 (1)  $T_{amb} = -55\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = 100\text{ °C}$

**Fig. 10. Base-emitter voltage as a function of collector current; typical values**



$T_{amb} = 25\text{ °C}$   
 (1)  $I_B = 5\text{ mA}$   
 (2)  $I_B = 4.5\text{ mA}$   
 (3)  $I_B = 4\text{ mA}$   
 (4)  $I_B = 3.5\text{ mA}$   
 (5)  $I_B = 3\text{ mA}$   
 (6)  $I_B = 2.5\text{ mA}$   
 (7)  $I_B = 2\text{ mA}$   
 (8)  $I_B = 1.5\text{ mA}$   
 (9)  $I_B = 1\text{ mA}$   
 (10)  $I_B = 0.5\text{ mA}$

**Fig. 11. Collector current as a function of collector-emitter voltage; typical values**



$I_C/I_B = 20$   
 (1)  $T_{amb} = 100\text{ °C}$   
 (2)  $T_{amb} = 25\text{ °C}$   
 (3)  $T_{amb} = -55\text{ °C}$

**Fig. 12. Equivalent on-resistance as a function of collector current; typical values**

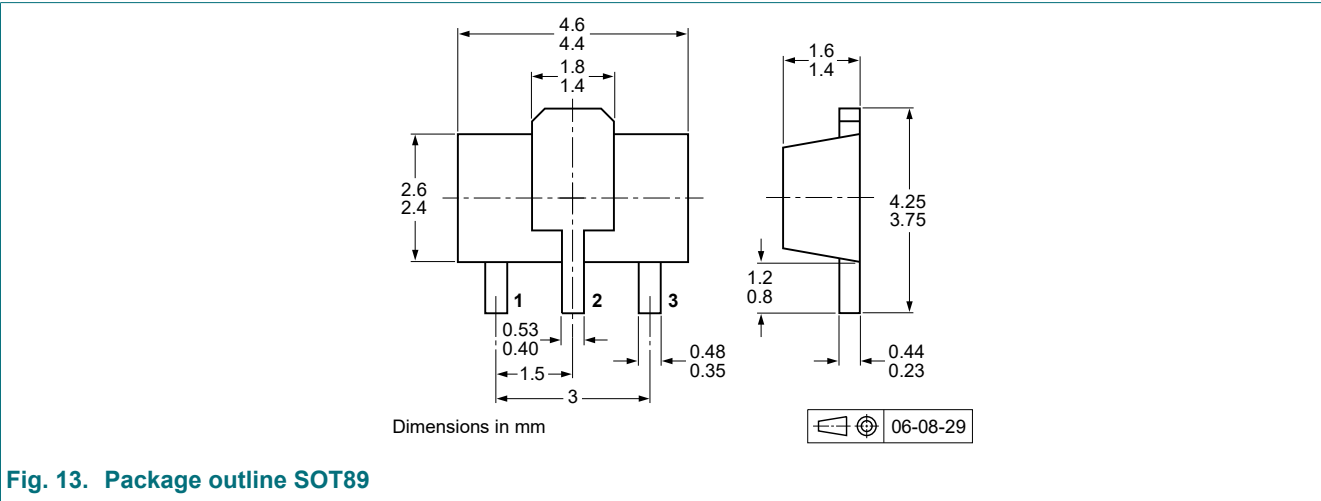


11. Test information

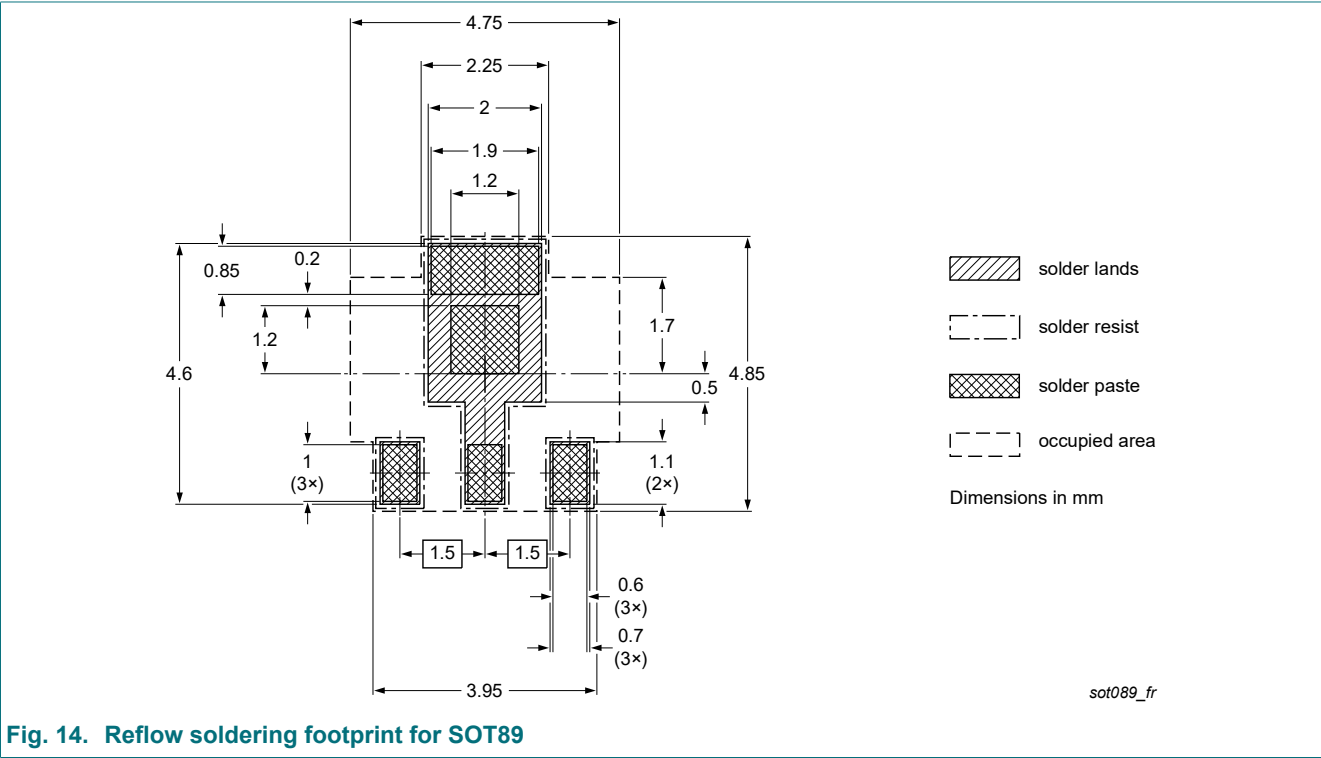
Quality information

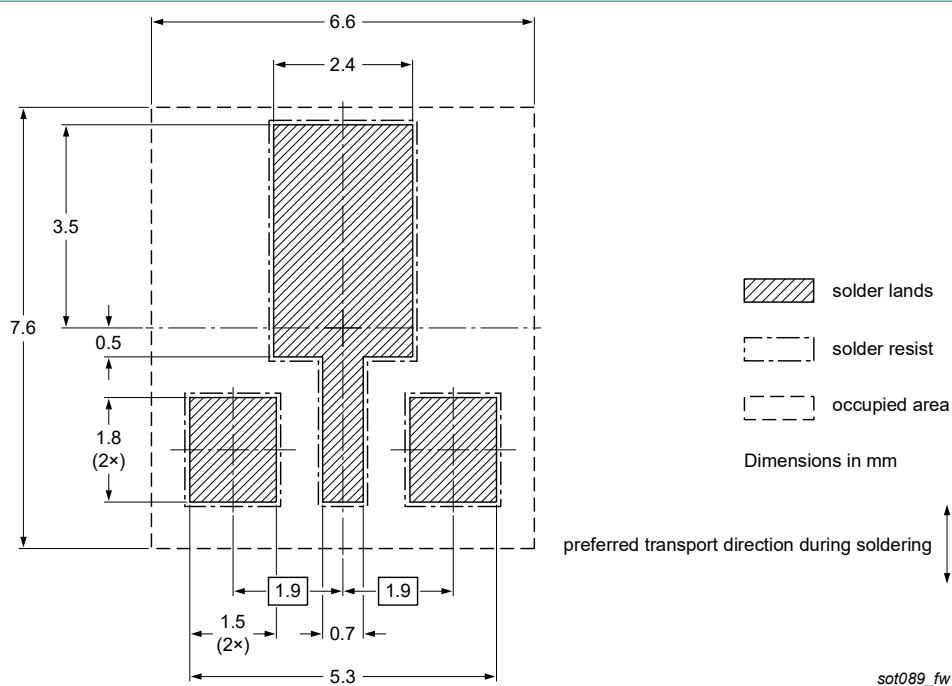
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





**Fig. 15. Wave soldering footprint for SOT89**

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4520X-Q v.1	20240119	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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